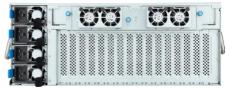


TBird-X-8GPU

GPU Server - 4U DP 10-GPU 12-bay NVMe/SATA







Features

- Supports up to 10 x double slot Gen5 GPU cards
- 4th Gen. Intel[®] Xeon[®] Scalable Processors
- Intel® Xeon® CPU Max Series
- Dual processor, LGA4677
- 8-Channel RDIMM DDR5, 32 x DIMMs
- Dual ROM Architecture supported
- 2 x 10Gb/s BASE-T LAN ports (Intel® X710-AT2)
- · 1 x dedicated management port
- 12 x 3.5/2.5" NVMe/SATA hot-swappable bays
- 1 x Ultra-Fast M.2 with PCle Gen3 interface
- 8 x FHFL PCIe Gen5 x16 slots for GPU cards
- 2 x LP PCIe Gen5 x16 MD2 expansion slots on front side
- · 3+1 3000W (240V) 80 PLUS Titanium redundant power supply

Specification

 Dimensions
 4U (W448 x H176 x D880 mm)
 Rear I/O
 N/A

Motherboard MSB3-G40

CPU 4th Gen Intel® Xeon® Scalable Processors

Intel® Xeon® CPU Max Series

Intel® Xeon® Platinum Processor, Intel® Xeon® Gold Processor,

Intel® Xeon® Silver Processor CPU TDP up to 350W

Socket 2 x LGA 4677 (Socket E)

Chipset Intel® C741 Chipset

Memory 8-Channel DDR5 memory, 32 x DIMM slots

RDIMM modules up to 128GB supported 3DS RDIMM modules up to 256GB supported

Memory speed: Up to 4800 MHz (1DPC), 4400 MHz (2DPC)

LAN 2 x 10Gb/s BASE-T LAN ports (Intel® X710-AT2)

Supported NCSI function

1 x 10/100/1000 management LAN

Video Integrated in Aspeed AST2600

2D Video Graphic Adapter with PCIe bus interface

1920x1200@60Hz 32bpp, DDR4 SDRAM

Storage 12 x 3.5" SATA/SAS hot-swappable bays

SAS card is required for SAS devices support

RAID Intel SATA RAID 0/1/10/5

Expansion 10 x PCIe Gen5 x16 FHFL slots for GPUs on rear side Slots 2 x PCIe Gen5 x16 Low-profile MD2 slots on front side

1 x M.2 slot (M-key, PCle Gen3 x1, supports 2280/22110)

Front **VO** 2 x USB 3.2 Gen1, 1 x VGA, 2 x RJ45, 1 x MLAN

Backplane I/O PCIe Gen5 x4 or SATA 6Gb/s or SAS 12Gb/s

TPM 1 x TPM header with SPI interface

Optional TPM2.0 kit: CTM010

Power Supply 3+1 3000W (240V) 80 PLUS Titanium redundant power supply

AC Input: 100-240V

System Aspeed® AST2600 management controller
Management Management Console (AMI MegaRAC SP-X)

Windows Server 2019 / 2022

Compatibility RHEL 8.4 / 8.5 / 8.6 / 8.7 / 9.0 / 9.1 (x64)

SLES 15 SP3 / 15 SP4 (x64) Ubuntu 22.04 LTS / 22.04.1 LTS (x64) VMware ESXi 7.0 Update 3i / 8.0

System Fans 6 x 60x60x38mm (23,000rpm), 4 x 40x40x28mm (25,000rpm)

Operating Operating temperature: 10°C to 35°C

Properties Operating humidity: 8-80% (non-condensing)

Non-operating temperature: -40°C to 60°C Non-operating humidity: 20%-95% (non-condensing)

Packaging 1 x G493-SB1, 2 x CPU heatsinks, Content 6 x Carrier clips, 1 x Rail kit

Reference Barebone package: 6NG493SB1DR000AAP1*
Numbers Methodograf: 0MSB3C40NB 000

- Motherboard: 9MSB3G40NR-000 - Rail kit: 25HB2-A96100-K0R

- CPU Fan-sink: 25ST1-363204-C1R - Back plane board_12-port_3.5": 9CBP20C7NR-00

- Power supply: 25EP0-230005-G1S

- C19 power cord 125V/15A (US): 25CP1-018000-Q0R (optional)

- C19 power cord 250V/16A (EU): 25CP3-01830H-Q0R (optional)

Learn more about Transource server, visit https://www.transource.com

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